Thermal Conductivity of 2-D Covalent Organic Framework and Enhancing Using Fullerene 3-D Self-assembly: A Molecular Dynamics Simulation

Daili Feng *†§, Yanhui Feng *†§, Yazhou Liu†, Weishuo Zhang†, Yuying Yan‡,

Xinxin Zhang†§

† School of Energy and Environmental Engineering, University of Science and Technology Beijing, Beijing 100083, China

§Beijing Key Laboratory of Energy Saving and Emission Reduction for Metallurgical Industry, University of Science and Technology Beijing, Beijing 100083, China

‡ Fluids & Thermal Engineering Research Group, Faculty of Engineering, University of Nottingham, Nottingham NG7 2RD, UK

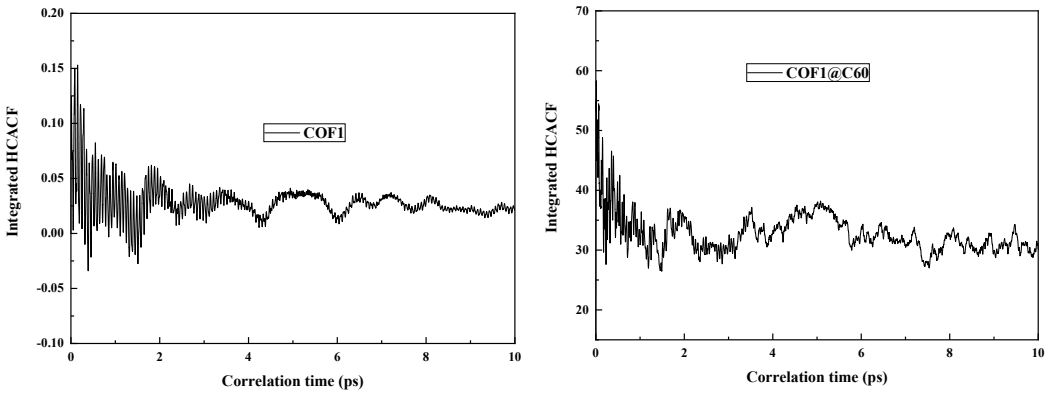
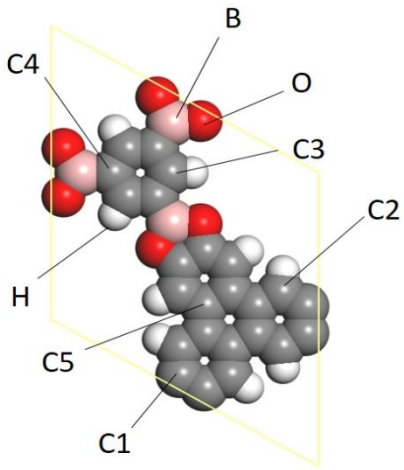


Figure S1. Time-dependent integral HCACF of (a) COF-1 and (b) C60@COF-1.



a=b=14.974,c=3.3986, α=β=90°, γ=120°

Figure S2. The structural motif and atomic types of COF-6.

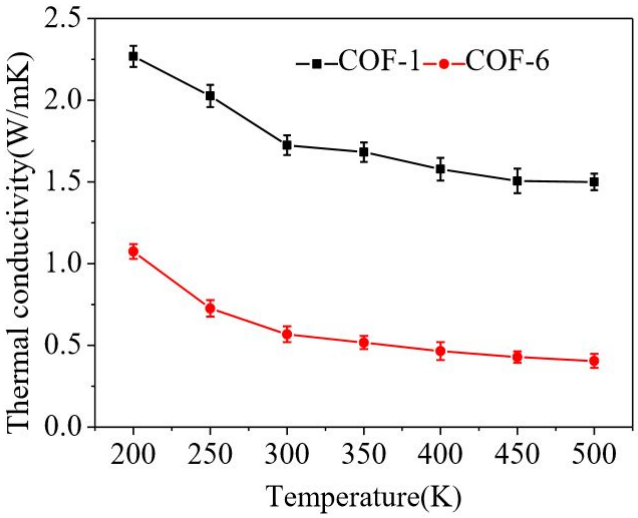


Figure S3. The MD prediction of thermal conductivity for COF-6.